Modeling on dynamic recrystallization of aluminium alloy 7050 during hot compression based on cellular automaton

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Abstract: The dynamic recrystallization (DRX) process of hot compressed aluminium alloy 7050 was predicted using cellular automaton (CA) combined with topology deformation. The hot deformatation characteristics of aluminium alloy 7050 were investigated by hot uniaxial compression tests in order to obtain the material parameters used in the CA model. The influences of process parameters (strain, strain rate and temperature) on the fraction of DRX and the average recrystallization grain (R-grain) size were investigated and discussed. It is found that larger stain, higher temperature and lower strain rate (less than 0.1 s^{-1}) are beneficial to the increasing fraction of DRX. And the deformation temperature affects the mean R-grain size much more greatly than other parameters. It is also noted that there is a critical strain for the occurrence of DRX which is related to strain rate and temperature. In addition, it is shown that the CA model with topology deformation is able to simulate the microstructural evolution and the flow behavior of aluminium alloy 7050 material under various deformation conditions.

Key words: cellular automaton; dynamic recrystallization; aluminium alloy 7050; flow stress

1 Introduction

Aluminum alloy 7050 is a typical structural material with high strength and toughness, and it is widely used in automotive and aviation industry [1-3]. In order to meet the ever-increasing requirements of the synthetic property of aluminum alloy, grain refinement is an available approach which is mostly induced by large plastic deformation [4-5]. For most metals and alloys, the refined grains are dependent heavily on the occurrence of dynamic recrystallization (DRX) during hot working [6–8]. Therefore, it is of great significance to anticipate and manage the microstructure evolution of aluminum alloys undergoing hot deformation. For the purpose of fulfilling this target, process parameters including strain, temperature and strain rate, should be reasonably arranged [9-10]. As DRX is a complex dynamic process [11-12], it is time-consuming and costly if various combinations of process parameters are successively tried out in a traditional manner. In recent years, cellular automaton (CA) method has been applied to investigate the complex microstructural evolution during dynamic recrystallization because of its high efficiency and flexibility [13-15]. DING and GUO [16] coupled metallurgical principles with the CA method to predict the microstructural evolution and the flow stress of copper under kinds of working conditions, and the simulated values are in agreement with the experimental results. CHEN et al [17] also adopted the CA method to simulate the DRX of 30Cr2Ni4MoV rotor steel and the microstructure evolution before DRX was considered. XIAO et al [18] realized the microstructure evolution of DRX by integrating a CA model with the topology deformation technique which is based on vector operation. Although most experimental researches have been carried out on the flow behavior and microstructural evolution of aluminium alloy 7050 [9-10, 19–21], few attempts are made on the simulation of DRX of this material. HUANG et al [22] developed a CA program to research the influence of the deformation parameters on the fraction of DRX and the mean size of recrystallized grain (R-grain) for aluminium alloy 7050. However, the topology deformation was neglected in his simulation. As a result, the numerical result might not be completely in accordance with the experimental process and further developments on the simulation method are needed.

In this work, a CA model with a 2D matrix coupling with a topology deformation technology was established based on the platform of MATLAB and used to estimate the DRX behavior of aluminium alloy 7050. The hot compression tests of aluminum alloy 7050 were conducted to obtain the material parameters and the

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constitutive model for the CA simulation. Then, the process of CA simulation was developed including the topology deformation, followed by the CA simulation results of microstructural evolution. And the influences of process parameters including strain, stain rate and temperature on the percentage of DRX and the mean R-grain size of 7050 material were analyzed and discussed.

2 Experiments and constitutive model

2.1 Experiments of hot compression tests of aluminum alloy 7050

A series of uniaxial hot compression tests of aluminum alloy 7050 was conducted to obtain the material parameters for the CA simulation. The cylindrical specimens have a diameter of 10 mm and a height of 15 mm. The chemical composition of aluminium alloy 7050 (mass fraction, %) is shown in Table 1. All the hot compression tests were performed on a Gleeble-1500 thermo-simulation machine in the

 Table 1 Chemical composition of 7050 aluminium alloy (mass fraction, %)

Ti	Si	Zr	Fe	Cu	Mg	Zn	Al	indicates the occurrence of DRX during hot
0.06	0.12	0.13	0.15	2.60	2.60	6.70	Bal.	In general, at a given temperature, the high
	160) (a)						120 (b)
	e120	p - /						100
	True stress					- 0.01 s		10^{33} 10^{-1} -0.01 s^{-1} 0.1 s^{-1}
	40					$\cdot 1 \text{ s}^{-1}$ $\cdot 10 \text{ s}^{-1}$		$20 \begin{array}{c} 0.1 \text{ s}^{-1} \\ \cdots 1 \text{ s}^{-1} \\ -\cdots 10 \text{ s}^{-1} \end{array}$
		0	0.2	0.4 True	0.6 strain	0.8	3 1.0) 0 0.2 0.4 0.6 0.8 True strain
	100) (c)					_ .	100 (d)
	88 88	o - /	••••••				•	
	e stress/							se 40
	90 40 E 20))				0.0 0.1	$\frac{1}{s^{-1}}$	$\begin{array}{c} = \\ 20 \end{array} \begin{array}{ c } \hline -0.01 \ s^{-1} \\ -0.1 \ s^{-1} \\ 1 \ s^{-1} \end{array}$
		0	0.2	0.4	0.6	10 0.8	$\frac{s^{-1}}{s^{-1}}$	$0 \qquad 0 \qquad$
			•	True	strain	5.0		True strain

temperature range of 300 °C–450 °C and in the strain rate range of 0.01 s⁻¹ to 10 s⁻¹.

Each specimen was heated to a required deformation temperature at an increasing rate of 3 °C/s, and then was held for 5 min to eliminate the unevenness. In order to minimize the influence of the friction between the specimen and the die on the stress state, thin graphite flakes were placed between the specimen and the punch. Additionally, argon atmosphere was assured to prevent from oxidation during the test, and the samples were taken out quickly and quenched with room temperature water when the amount of deformation reached 85%.

Figure 1 shows the true stress–strain curves achieved from hot compression tests of aluminium alloy 7050 at various temperatures and strain rates. On the whole, with the increase of strain, the stress increases at first. Then the increasing rate of the flow stress slows down. After experiencing a peak value, the flow stress decreases or directly goes to a relatively steady state. In addition, the flow stress increases with the increase of the strain rate at a given temperature and decreases with the rising temperature when the strain rate is fixed. Further, when the strain rate $\dot{\varepsilon} \leq 0.1 \text{ s}^{-1}$, the flow stress lowers down evidently after a peak value, which indicates the occurrence of DRX during hot deformation. In general, at a given temperature, the higher the strain

1.0

1.0

Fig. 1 Typical true stress–strain curves for 7050 aluminium alloy at various strain rates and temperatures: (a) 300 °C; (b) 350 °C; (c) 400 °C; (d) 450 °C

rate, the later the DRX. However, when the strain rate $\dot{\varepsilon} \ge 1 \text{ s}^{-1}$, the significant drop of the flow stress does not occur and the flow stress peak value is immediately maintained, which presents a phenomenon of dynamic recovery.

2.2 Establishment of model of flow stress at high temperature

When plastic deformation occurs for a given material, atomic diffusion and dislocation motion are determined by the deformation temperature, and the dislocation density and the accumulating rate of grain boundary energy are dependent on the strain rate. Therefore, it can be considered that the peak flow stress is only influenced by the deformation temperature and the strain rate. Previous researches have shown that the relation between the flow stress and the two parameters can be expressed by mathematical models. In this work, the hyperbolic sine Arrhenius model [23], which considers the activation energy, the deformation temperature and the strain rate, was selected.

$$\dot{\varepsilon} = A[\sinh(\alpha\sigma)]^n \exp(-Q_{act}/RT) \tag{1}$$

where $\dot{\varepsilon}$ is the strain rate; *T* is the deformation temperature; Q_{act} is the activation energy; *A*, α and *n* are constants which need to be calculated; *R* is gas constant (*R*=8.314 kJ/mol); and σ is the flow stress.

And the hyperbolic sine Arrhenius model has two forms:

$$\dot{\varepsilon} = A_1 \sigma^n \exp(-Q_{\text{act}}/RT), \ \alpha \sigma \le 0.8$$
 (2)

$$\dot{\varepsilon} = A_2 \exp(\beta \sigma) \exp(-Q_{act}/RT), \ \alpha \sigma \ge 1.2$$
 (3)

where A_1 , A_2 , n_1 and β are contants. As $A_1 = A\alpha^{n_1}$, $A_2=A/2^n$, and $\beta=\alpha n_1$, the equations can be transformed as follows:

$$\ln \dot{\varepsilon} = \ln A_1 + n_1 \ln \sigma - Q_{\text{act}} / RT \tag{4}$$

$$\ln \dot{\varepsilon} = \ln A_2 + \beta \sigma - Q_{\text{act}} / RT \tag{5}$$

When the deformation temperaturea *T* is definite, n_1 and β correspond to the slopes of the curves of $\ln\sigma$ -ln $\dot{\varepsilon}$ and σ -ln $\dot{\varepsilon}$, respectively. Figures 2(a) and (b) show the relationships of $\ln \sigma - \ln \dot{\varepsilon}$ and $\sigma - \ln \dot{\varepsilon}$ at different temperatures through linear regression. According to the slopes of these curves, n_1 =9.5324 and β =0.11894 MPa⁻¹, and α =0.012478 MPa⁻¹ as β = αn_1 .

In addition, at a given deformation temperature, Eq. (1) can be changed into the following equation by taking natural logarithms on both sides:

$$\ln \dot{\varepsilon} = \ln A + n \ln [\sinh(\alpha \sigma)] - Q_{act} / RT$$
(6)

It is certain that $\ln \dot{\varepsilon}$ and $\ln[\sinh(\alpha\sigma)]$ present a linear relationship as shown in Fig. 3. As the slopes of the linear regression curves are 1/n, *n* is calculated to be 7.04359. Meanwhile, the intercepts of these curves equal to $(Q_{act}/RT-\ln A)/n$.



Fig. 2 Relationship between peak stress and strain rate: (a) $\ln \sigma - \ln \dot{\varepsilon}$; (b) $\sigma - \ln \dot{\varepsilon}$



Fig. 3 Relationship between $\ln[\sinh(\alpha\sigma)]$ and $\ln \mathscr{S}$

Further, if the strain rate is definite, take natural logarithms on both sides of Eq. (1) and another expression would be obtained as follows:

$$\ln[\sinh(\alpha\sigma)] = Q_{act}/nRT - \ln A/n$$
(7)

From regression analysis, the relationship between $\ln[\sinh(\alpha\sigma)]$ and T^{-1} is still linear at a certain strain rate as shown in Fig. 4. The slopes of the four curves are Q_{act}/Rn , and the average value can be calculated to be 2487.2605 as n=7.04395 and R=8.314 kJ/mol, $Q_{act}=145.66$ kJ/mol. Considering that the intercepts of curves in Fig. 3 are $(Q_{act}/nRT-\ln A)/n$ and Q_{act} , R, T and n are known, we get $A=6.076 \times 10^{10}$ s⁻¹.



Fig. 4 Relationship between $\ln[\sinh(\alpha\sigma)]$ and T^{-1}

After substituting the calculated value of Q_{act} , A and α into Eq. (1), the peak flow stress models of aluminum alloy 7050 under the experimental conditions are as follows:

$$\dot{\varepsilon} = 6.076 \times 10^{10} \left[\sinh \left(0.012478\sigma \right) \right]^{7.04395} \cdot \exp \left(-145.6624 / RT \right)$$
(8)

$$\sigma = \frac{1}{0.012478} \ln \left\{ \left(\frac{\dot{\varepsilon} \exp(145662.4/RT)}{6.076 \times 10^{10}} \right)^{\frac{1}{7.04395}} + \left[\left(\frac{\dot{\varepsilon} \exp(145662.4/RT)}{6.076 \times 10^{10}} \right)^{\frac{2}{7.04395}} + 1 \right]^{\frac{1}{2}} \right\}$$
(9)

In this way, the calculated values of peak flow stress under different deformation conditions can be achieved by Eq. (9), and the experimental values can be obtained from the true stress–strain curves of hot compression experiments. Table 2 shows the comparison of the calculated and experimental values of peak flow stress. It is shown that the errors between them are almost less than 8%. Thus, the previous flow stress model is proved to be able to describe the experimental peak stress accurately.

3 Simulation procedures

3.1 Theoretical rules of CA model

It is commonly believed that DRX won't occur until the dislocation density or the strain reaches a critical value which is dependent on thermo-mechanical parameters such as deformation temperature and strain rate. In this work, two assumptions are made so as to simplify the CA model.

1) The dislocation density of all the grains within the matrix is initially uniform and then increases with the

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 Table 2 Comparison of peak stress between calculation and experiments

Temperature/	Strain	Stress/	Relative	
°C	rate/s ⁻¹	Experimental	mental Calculated	
	0.01	78.83	81.10	2.80
200	0.1	113.33	111.30	1.823
300	1	126.84	124.50	1.880
	10	139.25	149.00	6.543
	0.01	59.83	60.53	1.146
250	0.1	76.82	78.81	2.524
330	1	98.40	99.85	1.456
	10	118.88	122.94	3.303
	0.01	43.02	46.71	7.907
400	0.1	61.53	62.10	0.916
400	1	82.54	80.66	2.326
	10	100.88	101.92	1.023
	0.01	32.00	33.94	5.715
450	0.1	51.22	49.79	2.865
430	1	66.25	65.89	0.550
	10	90.29	85.10	6.10

increase of strain. When it exceeds the critical dislocation density, the nucleation of DRX comes out. And the dislocation density of a newly nucleated grain is initially presumed to be zero and will also be able to become larger as the strain increases.

2) DRX occurs on the grain boundaries and the dynamically recrystallized grain boundaries.

3.1.1 Model of dislocation density

The development of dislocation density is generally determined by work hardening and dynamic recovery softening. The variation of the dislocation density of cell (i, j) in a matrix in respect of strain can be expressed as [16]:

$$d\rho/d\varepsilon = k_1 \rho_{i,j}^{1/2} - k_2 \rho_{i,j}$$
(10)

where k_1 is a constant coefficient representing work hardening and k_2 is the softening parameter that represents recovery of dislocation. Then, the overall dislocation density ρ can be expressed as $\rho = \frac{1}{N} \sum_{i,j} \rho_{i,j}$,

and *N* is the sum of cells in the matrix.

According to the assumption of Kocks-Meching model (K-M model) [24], the correlation between the flow stress σ , an external variable, and the dislocation density ρ , an internal variable, is $\sigma=\alpha\mu b \sqrt{\rho}$, where α is a dislocation interaction constant which is around 0.5 for most metals, μ is the shear modulus and *b* is Burger's vector. It should be noted that the shear modulus varies with the deformation temperature *T* and can be expressed as:

$$\mu = \mu_0 [1 - 0.91 \times (T - 300) / T_m] \tag{11}$$

where μ_0 equals the shear modulus at room temperature and T_m is the material's melting temperature.

From Eq. (10), it can be deduced that

$$d\sigma/d\varepsilon = \theta_0 (1 - \sigma/\sigma_s) \tag{12}$$

where $\theta_0 = \alpha \mu b k_1/2$ and $\sigma_s = \alpha \mu b k_1/k_2$. θ_0 is the hardening rate which equals the slope of the experimental flow stress-strain curve in the stage of working hardening at a specific temperature and σ_s is the saturated stress which can also be obtained from the stress-strain curve [17]. Therefore, the two coefficients k_1 and k_2 in Eq. (10) can be calculated under the condition of $k_1=2\theta_0/(\alpha\mu)$ and $k_2=2\theta_0 b/\sigma_s$ as long as θ_0 and σ_s are determined.

3.1.2 Model of DRX nucleation

As mentioned before, DRX nucleation is assumed to only occur on the grain boundaries. The nucleation rate of per unit grain boundary area (length for 2D model) for DRX can be described as a function of both temperature and strain rate [16]:

$$\dot{\eta} = C\dot{\varepsilon}^m \exp(-Q_{\rm act} / RT) \tag{13}$$

where *C* is a constant, and $\dot{\varepsilon}$ is the strain rate given by Eq. (8). Meanwhile, the exponent *m* is set to be 1 in the present work.

3.1.3 Model of grain growth

It is commonly thought that the growth of a grain is thermo-dynamically activated by the difference between the dislocation densities of the R-grain and the matrix [17]. The velocity of grain growth v_i for the *i*th R-grain is generally expressed as [16]:

$$v_i = M f_i = M F_i / (4\pi r_i^2) \tag{14}$$

where f_i is the driving force per unit area for the *i*th R-grain with the assumption that the R-grain is spherical and has a radius of r_i , M is the GB mobility [25] and $M=(\delta D_b b/KT)\exp(-Q_b/RT)$. With the growth of r_i , the driving force $F_i=4\pi r_i \tau (\rho_m-\rho_i)-8\pi r_i \gamma_i$, where ρ_m is the dislocation density of the matrix, ρ_i is the dislocation density of the *i*th R-grain and γ_i is the GB energy given as [25]

$$\gamma_{i} = \begin{cases} \gamma_{\rm m}, \ \theta_{i} \ge 15^{\circ} \\ \gamma_{\rm m} \frac{\theta_{i}}{\theta_{\rm m}} \left(1 - \ln \frac{\theta_{i}}{\theta_{\rm m}} \right), \ \theta_{i} < 15^{\circ} \end{cases}$$
(15)

where θ_i is the misorientation between the *i*th R-grain and its neighboring grain, θ_m (taken as 15°) and γ_m are the misorientation and the GB energy of a high angle grain boundary, respectively.

3.2 CA model

3.2.1 CA model of grain growth

In the present study, a 2D square lattice is employed using MATLAB platform. Each cell corresponds to an element of the matrix and has four state variables: the dislocation density variable which can be calculated from Eq. (11), the grain orientation variable which can discriminate different grains and the values of GB energy, the GB variable which indicates whether the cell is located at the GB, and the fraction variable which represents recrystallization fraction. The recrystallization fraction can be normally calculated from the following equation [18]:

$$f_t = \int_0^t v_i dt / l_0 \tag{16}$$

where f_t represents the recrystallization fraction of a cell at the GB at time *t* and l_0 is the length of a unit cell (4 µm in this simulation).

The present square lattice is set to 400×400 and the periodic boundary condition is employed. The size of each cell represents 4 µm of the real dimension of the material and thus the total simulation area is equivalent to a real sample with the area of 1.6 mm×1.6 mm. The initial microstructure as shown in Fig. 5 is generated using a normal grain growth algorithm [16].

Then, the simulation of thermal compression of aluminium alloy 7050 is conducted under various deformation conditions. The the input parameters for the 7050 aluminium alloy material are shown in Table 3, where b is the Burger's constant, μ_0 the shear modulus at room temperature, Q_b the boundary diffusion activation energy, Q_{ac} the active energy, δ the



Fig. 5 Generated initial microstructure before simulation (Unit: mm)

Table 3 Material parameters for aluminium alloy 7050

<i>b</i> /nm	$\mu_0/$ GPa	Q_{b} /(kJ·mol ⁻¹)	$Q_{\rm act}/({\rm kJ}{\cdot}{ m mol}^{-1})$	$\delta D_{ m b}/\ ({ m m}^3 \cdot { m s}^{-1})$	$T_{\rm m}/{ m K}$
0.2	25.9	117.2	145.662	3.8×10 ⁻¹⁴	903.15

characteristic grain boundary thickness, D_b the boundary self-diffusion coefficient, and T_m the material's melting temperature.

3.2.2 Topological deformation for CA model

It should be noticed that as the size of the matrix varies during hot compression deformation, the topology deformation should be considered. In this work, it is realized that the matrix transformation for every cell is determined by its location (i, j) in the matrix. The matrix transformation includes two aspects: one is the size of the matrix, with the assumption that an initial $a \times b$ matrix S(a,b) transforms into one with the size of $m \times n S(m,n)$. The other is the state transfer of a given cell after transformation. If the current true strain is ε_t , the column number of the formed matrix, n, can be calculated as n= $bexp(-\varepsilon_t)$. And the row number m can be obtained from m=ab/n for the volume (area for a 2D model) remaining constant during deformation. As the values of m and nshould be integers, it will bring about the calculation error for the simulated deformation area. It is confirmed that all the round-off area errors are less than 0.5% at various strains when the 400×400 matrix is employed, indicating an acceptable precision. Further, as different cells have different state variables, the state transfer of cells should be implemented to avoid the confusion of grains. In essence, the transformation from cell C(i, j) in the initial matrix S(a, b) to cell C(x, y) in the transformed matrix S(m, n) can be successfully carried out in terms of the following rule:

$$i = \begin{cases} ceil [x \cdot (1 - \varepsilon_{e})], ceil [x \cdot (1 - \varepsilon_{e})] < a \\ a, ceil [x \cdot (1 - \varepsilon_{e})] \ge a \end{cases}$$
$$j = \begin{cases} ceil (\frac{y}{1 - \varepsilon_{e}}), ceil (\frac{y}{1 - \varepsilon_{e}}) < b \\ b, ceil (\frac{y}{1 - \varepsilon_{e}}) \ge b \end{cases}$$
(17)

where ε_e is the engineering strain and *ceil*(*x*) is a round function which returns the minimum integer larger than *x*. In each deformation step of the present simulation, as the strain increment is known, the geometrical position of each cell can be updated based on this topology deformation model. In this way, the evolution of grain topology during deformation can be simulated.

4 Results and discussion

4.1 Comparison of flow stress-strain curves

The previously proposed CA model was adopted to simulate the process of DRX of aluminium alloy 7050 at different temperatures and strain rates. Figure 6 exhibits the simulated and experimental flow stress–strain curves at different temperatures (300–450 °C) and strain rates (0.01–10 s⁻¹). The numerical stress value is a little larger



Fig. 6 Comparison of simulated and experimental flow stress–strain curves: (a) At different temperatures; (b) At different strain rates

than the experimental one, and the largest error between them happens at the peak stage. The reason might be that in the simulation the nucleation is assumed to only occur at the grain boundary and the initial dislocation density gradient in each grain is ignored. In addition, it is difficult to measure the actual dislocation density of material and thus the dislocation density in the simulation is not accuracy enough. However, on the whole, the simulated flow stress–strain curves are generally in agreement with the actual experimental curves, indicating that the CA model is effective.

4.2 Effect of strain on DRX

Figure 7 illustrates the microstructure evolution of aluminium alloy 7050 with different stains at the temperature of 450 °C and the strain rate of 0.01 s⁻¹. The regions in different colors represent the newly formed recrystallized grains with different crystallographic orientations and the white regions are the deformed matrix. It is noted when the temperature and the stain rate are kept constant during hot compression, the amount of recrystallization nuclei grows significantly with the increase of strain. The fraction of DRX as well as the average R-grain size under four certain conditions of strain is shown in Table 4. It is certain that the fraction



Fig. 7 Microstructure evolution with different stains at T=450 °C and $\dot{\varepsilon}$ =0.01: (a) ε =0.2; (b) ε =0.4; (c) ε =0.6; (d) ε =0.8

 Table 4 Fraction of DRX and average R-grain size with different strains

Strain	Fraction of DRX/%	R-grain size/µm
0.2	7.95	57.83
0.4	20.69	59.54
0.6	30.68	59.86
0.8	41.17	60.53

of DRX increases largely from 7.95% to 41.17% with increasing strain. However, the R-grain size increases very slowly as the value of strain grows. This phenomenon is generally in accordance with the results by HU et al [26].

4.3 Effect of strain rate on DRX

The simulation result of recrystallized process at certain strain rates (0.01 s⁻¹, 0.1 s⁻¹, 1 s⁻¹ and 10 s⁻¹) at 450 °C and strain of 0.85 is shown in Fig. 8. Figure 9 presents the history of the fraction of DRX with increasing strain. It can be seen that the corresponding values of the average R-grain size when the strain rates varies from 0.01 s⁻¹ to 10 s⁻¹ are 59.83 µm, 37.54 µm,

11.6 μ m and 5.52 μ m, respectively, and the relevant fractions of DRX are 46.67%, 19.17%, 1.67% and 0.26% in sequence. At a strain rate greater than 1 s⁻¹, the proportion of DRX is rather small as the deformation is so quick that few R-grains are generated during the process. However, when the strain rate decreases to 0.01 s⁻¹, the fraction of DRX increases swiftly to 46.67%, indicating that a low strain rate is beneficial to the occurrence of DRX at a fixed temperature. It is interesting to find that the simulated R-grain size at a high strain rate is much smaller. Even so, the fraction of DRX is very low and can be negligible. It shows that the recrystallization nearly does not occur under the condition of high strain rate.

The metallographical images at different strain rates $(0.01 \text{ s}^{-1}, 0.1 \text{ s}^{-1}, 1 \text{ s}^{-1} \text{ and } 10 \text{ s}^{-1})$ at 450 °C and with the strain of 0.85 are shown in Fig. 10. It presents that the grain size increases gradualy with the decrease of strain rate. The uniform and fine microstructures are obtained when the strain rate is 0.1 s⁻¹. However, when the strain rate decreases to 0.01 s⁻¹, the grains become coase evidently. This is because there is no enough time for recrystallization at high strain rate as mentioned before.



Fig. 8 Effect of strain rate on simulation microstructure evolution (*T*=450 °C and ε =0.85): (a) $\dot{\varepsilon} = 0.01 \text{ s}^{-1}$; (b) $\dot{\varepsilon} = 0.1 \text{ s}^{-1}$; (c) $\dot{\varepsilon} = 1 \text{ s}^{-1}$; (d) $\dot{\varepsilon} = 10 \text{ s}^{-1}$



Fig. 9 History of fraction of DRX with increasing stain at different strain rates (*T*=450 °C)

And the experimental images exhibit the same result with simulation, verifying the effectiveness of the DRX model.

4.4 Effect of temperature on DRX

Figrue 11 shows the simulation microstructure evolution under different temperatures with the strain rate of 0.01 s⁻¹ and the strain of 0.85. It is calculated that

the average sizes of R-grain with temperature from 300 °C to 450 °C are 12.87, 17.36, 20.89 and 59.83 µm in turn. Figure 12 presents the relation between the fraction of DRX and temperature. It is found that at a certain strain rate, both the fraction of DRX and the mean R-grain size increase with the increase of temperature under the same condition of strain. This indicates that the effect of temperature on recrystallization is embodied in two aspects. On the one hand, the rising temperature provides the necessary energy and contributes to the nucleation and growth of R-grains. On the other hand, too high temperatures will lead to coarse grains. In short, when the stain is constant, the higher the temperature or the lower the strain rate, the easier the recrystallization phenomenon to occur. It is also noted from Fig. 6 and Fig. 8 that the recrystallization always happens when the strain reaches a critical value. When the temperature remains constant, the higher the strain rate, the larger the critical strain for the occurrence of DRX. And for a given stain rate, the higher the temperature, the smaller the critical strain.

The metallographical images under different temperatures with the strain rate of 0.01 s⁻¹ and the strain of 0.85 is shown in Fig. 13. It is found that there is only



Fig. 10 Metallographical image at different strain rates (T=450 °C and ε =0.85): (a) 0.01 s⁻¹; (b) 0.1 s⁻¹; (c) 1 s⁻¹; (d) 10 s⁻¹



Fig. 11 Effect of temperature on microstructure evolution: (a) T=300 °C; (b) T=350 °C; (c) T=400 °C; (d) T=450 °C



Fig. 12 History of fraction of DRX with increasing stain at different temperatures



Fig. 13 Metallographical images at different temperatures ($\dot{\varepsilon} = 0.01 \text{ s}^{-1}$ and $\varepsilon = 0.85$): (a) 300 °C; (b) 350 °C; (c) 400 °C; (d) 450 °C

microstructure of original grain, and no obvious recrystallization nucleation is seen at the temperature of 300 °C. At 350 °C, the fiber structure is stretched which means dynamic recovery has happened, there are some small grains or grain boundary which shows the recrystallization has occurred. With the temperature increases to 400 °C, the fiber structure and the small grains become bigger. When the temperature gets 450 °C, the recrystallization is more obvious, the recrystallization grain continues to grow up. The tendency shown in Fig. 13 is the same as the simulation result shown in Fig. 11, which proves the effectiveness of the simulation.

5 Conclusions

1) A model of flow stress at high temperature for simulating the dynamic recrystallization of aluminum alloy 7050 is developed and used to get the true stress-strain curve of the simulated deformation process. The flow stress results predicted from CA simulation are in good agreement with the experimental ones of hot compression tests, indicating that the proposed CA model could provide a theoretical reference for the control of the microstructure and properties of aluminium alloy 7050.

2) The influences of strain, strain rate and deformation temperature on the fraction of DRX and the average R-grain size are analyzed. It is found the fraction of DRX rises with the increase of strain and deformation temperature and with the decrease of strain rate. Meanwhile, the R-grain size increases a little when the strain increases, but increases significantly with the rising temperature. And although the simulated R-grain size at a high strain rate is much smaller, the fraction of DRX is very low and can be negligible.

3) The occurrence of the recrystallization is related to a critical value of strain. At the same temperature, a higher strain rate results in a larger critical strain for recrystallization. And at a given strain rate, the critical strain will become small when the temperature increases.

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